



PRINTERS, COPIERS & RETAIL

OUR CONNECTORS ARE ALL BUSINESS.

Drive affinity and loyalty for your hard working printers, copiers and retail equipment with reliable and durable solutions from TE Connectivity (TE). Low-cost and high-quality is key to the success of critical business and retail

machines. Our proven connectivity solutions and compact, next-generation connectors – for everything from 3D printers, to point of sale (POS) systems, and more – can help you deliver reliability at a competitive price.



WIRE-TO-BOARD

TE offers an extremely broad array of products for your wire-to-board requirements.



AMP CT Connectors

A product family with broad industry usage that features both Crimp and IDC style interconnect on 2mm centerline spacing, with many header options.



AMP Mini CT Connectors

Includes all of the features of AMP CT connectors in a more compact (1.5mm) design.



High Performance Interconnects (HPI)

Industry standard square-peg technology in single- and dualrow post headers available in various pitches and colors.



Custom Wire-to-Board

TE is a technology leader that can help you design custom wire-toboard cable assembly connectors for inkjet and other printer and electronic applications.

POWER

From internal and semi-internal to external power interconnects, TE keeps your power flowing.



Low Power Drawer Connectors

These economical rack and panel connectors feature excellent durability and allow for both power & signal in the same connector housing.



Power Double Lock Connectors

Smooth, compact design prevents snagging when mated and the double lock plate helps to ensure positive loading and to prevent contact back-out.



MATE-N-LOK Connectors

Error proof and secure mating solution is provided by mechanical and visual polarization features.



Dynamic Connectors

Flexible signal and power solutions with diverse housings to meet your control system needs for most applications.

BOARD-TO-BOARD (BTB)

TE's free height surface-mount connectors meet today's industry requirements for high density packaging.



0.6mm Free Height

Subminiature BTB connectors that can alter the spacing of parallel boards between 4mm and 8mm.



0.8mm Free Height

This popular connector system saves more than 50% board space compared to conventional 1.27mm centerline products.

INPUT/OUTPUT (I/O)

Product satisfaction requires reliable connectivity with the rest of the business network.



RJ45 Connectors

Our broad range of modular I/O jacks and plugs offer reliable and space-saving solutions.



USB Connectors

Universal and user-friendly, TE offers micro USB, USB 3.0, and the new high-power and reversable USB Type-C solutions.

CARD & SOCKET CONNECTORS

From IC sockets to SD cards, TE makes it easy to get connected and process, share or store data.



SD Card Connectors

Standard, micro, or micro/SIM combos with available push/push and push/pull matings.



Internal Processing

We carry an extensive line of IC and memory sockets including LGA sockets and reliable DDR4 DIMM connectors.

GROUNDING/SHIELDING

TE's miniaturized solutions help reduce and control the effect of EMI in complex systems.



Spring Fingers

Tiny, scalable, surface mountable contacts allow designers to fit grounding solutions almost anywhere.



Board Level Shielding (BLS)

Custom EMI shields that minimize crosstalk in tightly designed systems.

FLEX CONNECTORS

TE has high-density, small centerline spacing solutions, plus related contacts and accessories.



Flexible Printed Circuit (FPC)

Space saving solutions for signal routing. Available in 0.25 to 1.25mm centerlines in both ZIF and non ZIF styles.



Flat Flexible Cable (FFC)

Crimp style flex connection for FFC, FEC and FPC cable. Our reliable designs offer many housing options and leading application tooling.

ANTENNAS

Standard and custom highperformance antennas for most networks.



Embedded Antennas

A range of products supporting low profile wireless connectivity for 4G and 5GHz WiFi.



Custom Antennas

TE provides custom solutions addressing the increased complexity and demand for miniaturization.

